



RoHS Directive compatibility information http://www.nais-e.com/

SPECIFICATIONS

Contact					
Arrangement		2 Form C			
Contact materia		Gold alloy			
Initial contact re (By voltage drop	sistance 10V DC 10	Max. 150mΩ			
	Contact ra	ting	1W (at 5 GHz, Impedance 50 Ω, V.S.W.R. ≦ 1.25) 10mA 10V DC (resistive load)		
Rating	Contact ca	arrying power	1W (at 5 GHz, Impedance 50 Ω, V.S.W.R. ≦1.25)		
	Max. switc	hing voltage	30 V DC		
	Max. switc	hing current	0.3 A DC		
	V.S.W.R.		Max. 1.25		
High frequency	Insertion lo (without D	oss .U.T. board's loss)	Max. 0.5dB		
characteristics (Initial)		Between open contacts	Min. 35dB		
Impedance 50Ω	Isolation	Between contact sets	Min. 30dB		
,	Input powe	er	1W (at 5GHz, impedance 50Ω , V.S.W.R. ≤ 1.25 , at 20°C)		
	Mechanica	al (at 180 cpm)	107		
Expected life (min. operations)	Electrical (at 20cpm)	1W, at 5GHz, V.S.W.R. ≦ 1.25	106		
		10mA 10V DC (resistive load)	10 ⁶		

Coil (at 20°C, 68°F)

	Nominal operating power
Single side stable	200 mW
2 coil latching	150 mW

FEATURES

• Excellent high frequency characteristics (50Ω, at 5GHz)

SMD RELAYS

WITH 8GHz CAPABILITIES

V.S.W.R.: Max. 1.25 Insertion loss: Max. 0.5dB Isolation: Min. 35dB (Between open contacts) Min. 30dB (Between contact sets)

Surface mount terminal

Surface mount terminals are now standard so there is much less work in designing PC boards.

Small size

Size: 14.00 (L)×9.00 (W)×8.20 (H) mm

.551 (L)×.354 (W)×.323 (H) inch

RJ RELAYS (ARJ)

TYPICAL APPLICATIONS

Measurement equipment market Attenuator circuits, spectrum analyzer, oscilloscope, mobile equipment, tester Mobile telecommunication market IMT2000, microwave communication Medical instruments market

Characteristics

Initial insulat	tion resistance*1	Min. 500 MΩ (at 500 V DC)			
	Between open co	ntacts	500 Vrms		
	Between contact	sets	500 Vrms		
Initial breakdown	Between contact	and coil	500 Vrms		
voltage*2	Between coil and	earth terminal	500 Vrms		
-	Between contact a terminal	and earth	500 Vrms		
Operate time	e [Set time]*3 (at 20	0°C)	Max. 5ms [Max. 5 ms]		
Release tim (at 20°C)	e (without diode)[F	Reset time]*3	Max. 5ms [Max. 5 ms]		
Temperature	e rise (at 20°C)*4	_	Max. 50°C		
Shook rooid	2000	Functional*5	Min. 500 m/s ²		
SHOCK TESISI	ance	Destructive*6	Min. 1,000 m/s ²		
Vibration ro	viotonoo	Functional*7	10 to 55 Hz at double amplitude of 3 mm		
VIDIALIONTE	sistance	Destructive	10 to 55 Hz at double amplitude of 5 mm		
Conditions for transport an	or operation, d storage* ⁸	Ambient temp.	-30°C to 70°C -22°F to 158°F		
(Not freezing at low tempe	g and condensing erature)	Humidity	5 to 85% R.H.		
Unit weight			Approx. 3 g .11 oz		

Remarks

* Specifications will vary with foreign standards certification ratings.

*1 Measurement at same location as "Initial breakdown voltage" section.

*2 Detection current: 10mA

*3 Nominal operating voltage applied to the coil, excluding contact bounce time.

 *4 By resistive method, nominal voltage applied to the coil, 5GHz, V.S.W.R. $\leq\,$ 1.25

*5 Half-wave pulse of sine wave: 6ms, detection time: 10μ s.

*6 Pulse of sine wave: 11ms.

*⁷ Detection time: 10μs

ORDERING INFORMATION

Contact arrangemen	Operating function	Termin	al shape	Coil volta	age (DC)	Packin	g style	
2: 2 Form C	0: Single side stable 2: 2 coil latching	Nil: Standard PC A: Surface-mour	03 : 3V 4H: 4.5V 12 : 12V 24 : 24V Nil: Carton packing X: Tape end reel packing (picked from 1/2/3-pin side Z: Tape and reel packing (picked from 6/7/8-pin side)			ng packing /2/3-pin side) packing (picked side)		

Note: Tape and reel packing symbol "-Z" is not marked on the relay. "X" type tape and reel packing (picked from 1/2/3-pin side) is also available. Suffix "X" instead of "Z".

TYPES AND COIL DATA (at 20°C 68°F)

1. Standard PC board terminal

• Packing of standard PC board terminal: 50 pcs. in an inner package (carton); 500 pcs. in an outer package

		Part No.						Max.
Operating function	Coil Rating, V DC	Standard PC board terminal	Pick-up voltage, V DC (max.) (initial)	Drop-out voltage, V DC (min.) (initial)	Nominal operating current, mA (±10%)	Coil resistance, Ω (±10%)	Nominal operating power, mW	allowable voltage, V DC (at 70°C 158°F)
	3	ARJ2003	2.25	0.3	66.6	45	200	3.3
Single side	4.5	ARJ204H	3.375	0.45	44.4	101.2	200	4.95
stable	12	ARJ2012	9	1.2	16.6	720	200	13.2
	24	ARJ2024	18	2.4	8.3	2,880	200	26.4

		Part No.						Max.
Operating function	Coil Rating, V DC	Standard PC board terminal	Set voltage, V DC (max.) (initial)	Reset voltage, V DC (min.) (initial)	Nominal operating current, mA (±10%)	Coil resistance, Ω (±10%)	Nominal operating power, mW	allowable voltage, V DC (at 70°C 158°F)
	3	ARJ2203	2.25	2.25	50	60	150	3.3
2 coil	4.5	ARJ224H	3.375	3.375	33.3	135	150	4.95
latching	12	ARJ2212	9	9	12.5	960	150	13.2
-	24	ARJ2224	18	18	6.3	3,840	150	26.4

2. Surface-mount terminal

• Packing of surface-mount terminal: 50 pcs. in an inner package (carton); 500 pcs. in an outer package

• Packing of surface-mount terminal: 500 pcs. in an inner package (tape and reel); 500 pcs. in an outer package

		Part	No.						Max.
Operating function	Coil Rating, V DC	Carton packing	Tape and reel packing	Pick-up voltage, V DC (max.) (initial)	Drop-out voltage, V DC (min.) (initial)	Nominal operating current, mA (±10%)	Coil resistance, Ω (±10%)	Nominal operating power, mW	allowable voltage, V DC (at 70°C 158°F)
	3	ARJ20A03	ARJ20A03Z	2.25	0.3	66.6	45	200	3.3
Single side	4.5	ARJ20A4H	ARJ20A4HZ	3.375	0.45	44.4	101.2	200	4.95
stable	12	ARJ20A12	ARJ20A12Z	9	1.2	16.6	720	200	13.2
	24	ARJ20A24	ARJ20A24Z	18	2.4	8.3	2,880	200	26.4

		Par	t No.						Max.
Operating function	Coil Rating, V DC	Carton packing	Tape and reel packing	Set voltage, V DC (max.) (initial)	Reset voltage, V DC (min.) (initial)	Nominal operating current, mA (±10%)	Coil resistance, Ω (±10%)	Nominal operating power, mW	allowable voltage, V DC (at 70°C 158°F)
	3	ARJ22A03	ARJ22A03Z	2.25	2.25	50	60	150	3.3
2 coil	4.5	ARJ22A4H	ARJ22A4HZ	3.375	3.375	33.3	135	150	4.95
latching	12	ARJ22A12	ARJ22A12Z	9	9	12.5	960	150	13.2
	24	ARJ22A24	ARJ22A24Z	18	18	6.3	3,840	150	26.4

RJ (ARJ)

REFERENCE DATA

1. High frequency characteristics

Sample: ARJ20A12

Measuring method: Measured with MEW PC board by HP network analyzer (HP8510C).

• V.S.W.R. characteristics

DIMENSIONS

1. Standard PC board terminal





• Isolation characteristics



mm inch



2. Surface mount terminal



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NOTES

1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%. However, check it with the actual circuit since the characteristics may be slightly different. The nominal operating voltage should be applied to the coil for more than 20 ms to set/reset the latching type relay.

2. Coil connection

When connecting coils, refer to the wiring diagram to prevent mis-operation or malfunction.

3. External magnetic field

Since RJ relays are highly sensitive polarized relays, their characteristics will be affected by a strong external magnetic field. Avoid using the relay under that condition.

4. Cleaning

For automatic cleaning, the boiling method is recommended. Avoid ultrasonic cleaning which subjects the relays to high frequency vibrations, which may cause the contacts to stick. It is recommended that alcoholic solvents be used.

5. Tape and reel packing

1) Tape dimensions



2) Dimensions of plastic reel



6. Conditions for operation, transport and storage conditions

 Ambient temperature, humidity, and atmospheric pressure during usage, transport, and storage of the relay:
 Temperature:

-30 to $+70^{\circ}$ C -22 to $+158^{\circ}$ F (However, tolerance range is -30 to

+60°C -22 to +140°F if package is carried as is.)

(2) Humidity: 5 to 85% RH
(Avoid freezing and condensation.)
The humidity range varies with the temperature. Use within the range indicated in the graph below.
(3) Atmospheric pressure: 86 to 106 kPa Temperature and humidity range for usage, transport, and storage:



2) Condensation

Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation. 3) Freezing

Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags. 4) Low temperature, low humidity

environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.

5) Storage procedures for surface-mount terminal types

Since the relay is very sensitive to humidity, it is packed in humidity-free, hermetically sealed packaging. When storing the relay, be careful of the following points:

 Be sure to use the relay immediately after removing it from its sealed package.
 When storing the relay for long periods of time after removing it from its sealed package, we recommend using a humidity-free bag with silica gel to prevent subjecting the relay to humidity. Furthermore, if the relay is solder mounted when it has been subjected to excessive humidity, cracks and leaks can occur. Be sure to mount the relay under the required mounting conditions.

7. Soldering

1) Surface-mount terminal

In case of automatic soldering, the following conditions should be observed (1) Position of measuring temperature



(2) IR (infrared reflow) soldering method



Temperature rise of relay itself may vary according to the mounting level or the heating method of reflow equipment. Therefore, please set the temperature of soldering portion of relay terminal and the top surface of the relay case not to exceed the above mentioned soldering condition.

It is recommended to check the temperature rise of each portion under actual mounting condition before use. 2) Standard PC board terminal Please meet the following conditions if this relay is to be automatically soldered. (1) Preheating: Max. 120°C 248°F (terminal solder surface) for max. 120

seconds (2) Soldering: Max. 260±5°C 500±41°F

for max. 6 seconds

The effect on the relay depends on the actual substrate used. Please verify the substrate to be used.

Moisture-proof packaging enables RJ relay's standard PCB type capable for reflow soldering.

Please contact us in the case of reflow soldering considerations.

3) Hand soldering

Please meet the following conditions if this relay is to be soldered by hand. (1) Wattage: 30 to 60 W

(2) Tip temperature/time: 280 to 300°C 536 to 572°F for max. 5 seconds

The effect on the relay depends on the actual substrate used. Please verify the substrate to be used.

4) Avoid high frequency cleaning since this may adversely affect relay characteristics. Use alcohol-based cleaning solutions when cleaning relays.

RJ (ARJ)

Measuring method (Impedance 50 Ω)



Connector

No.	Product name	Contents		
1	HP 85131-60013	3.5 mm testport, Extension cable		
2	HP 83059	3.5 mm coaxial adaptor		

(Step 1) Calibrate the test system with HP calibration kit [HP85052B]

(Step 2) After calibration, connect the D.U.T. board and measure. Connect 50 Ω terminals on connectors other than those for measurement.

Notes)

1. All bottom surface of the base should be touched closely or soldered with PC board ground.

2.4 ribs should be soldered with PC board ground.

Measuring board

1) Dimensions

<Surface mount terminal>



<Standard PC board terminal>



<Calibration board>



2) Material: Glass PTFE double-sided through hole PC board R-4737 (Matsushita Electric Works)
3) Board thickness: t = 0.8 mm
4) Copper plating: 18µm

• Connector (SMA type receptacle) Product name: R125 510 (RADIALL) Insertion loss compensation The insertion loss of relay itself is given by subtracting the insertion loss of shortcircuit the Com and the NC (or NO). (signal path and two connectors)

8. Others

1) The switching lifetime is defined under the standard test condition specified in the JIS* C 5442-1996 standard (temperature 15 to 35°C 59 to 95°F, humidity 25 to 75%). Check this with the real device as it is affected by coil driving circuit, load type, activation frequency, activation phase, ambient conditions and other factors.

Also, be especially careful of loads such as those listed below.

• When used for AC load-operating and the operating phase is synchronous. Rocking and fusing can easily occur due to contact shifting.

• High-frequency load-operating When high-frequency opening and closing of the relay is performed with a load that causes arcs at the contacts, nitrogen and oxygen in the air is fused by the arc energy and HNO₃ is formed. This can corrode metal materials. Three countermeasures for these are

listed here. (1) Incorporate an arc-extinguishing

(1) Incorporate an arc-extinguishing circuit.

(2) Lower the operating frequency

(3) Lower the ambient humidity

2) Use the relay within specifications such as coil rating, contact rating and on/ off service life. If used beyond limits, the relay may overheat, generate smoke or catch fire.

3) Be careful not to drop the relay. If accidentally dropped, carefully check its appearance and characteristics before use.

4) Be careful to wire the relay correctly. Otherwise, malfunction, overheat, fire or other trouble may occur.

5) If a relay stays on in a circuit for many months or years at a time without being activated, circuit design should be reviewed so that the relay can remain non-excited. A coil that receives current all the time heats, which degrades insulation earlier than expected. A latching type relay is recommended for such circuits.

6) The latching type relay is shipped in the reset position. But jolts during transport or impacts during installation can change the reset position. It is, therefore, advisable to build a circuit in which the relay can be initialized (set and reset) just after turning on the power. 7) If silicone materials (e.g., silicone rubbers, silicone oils, silicone coating agents, silicone sealers) are used in the vicinity of the relay, the gas emitted from the silicone may adhere to the contacts of the relay during opening and closing and lead to improper contact. If this is the case, use a material other than silicone. 8) We recommend latching type when using in applications which involve lengthy duty cycles.

* Japanese Industrial Standards